



# THE DATASHEET OF PCMF2HDMI2SZ



# PCMFXHDMI2S series

Common-mode EMI filter for differential channels with integrated ESD protection

Rev. 2 — 19 April 2016

Product data sheet

## 1. Product profile

### 1.1 General description

Common-mode ElectroMagnetic Interference (EMI) filters with integrated ElectroStatic Discharge (ESD) protection for one, two and three differential channels. The devices are designed to provide low insertion loss for differential high-speed signals on each channel while unwanted common-mode signals are attenuated.

Each differential channel incorporates two signal lines that are coupled by integrated coils. Diodes provide protection to downstream components from ESD voltages up to  $\pm 15$  kV on each signal line.

Table 1. Product overview

Type number	Number of channels	Package Name
PCMF1HDMI2S	1	WLCSP5
PCMF2HDMI2S	2	WLCSP10
PCMF3HDMI2S	3	WLCSP15

### 1.2 Features and benefits

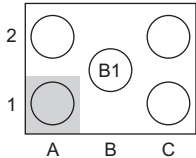
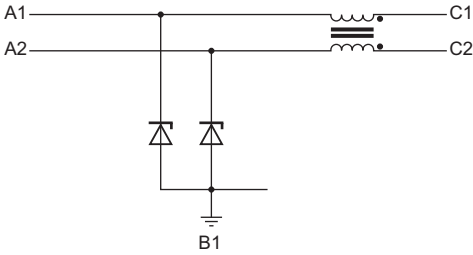
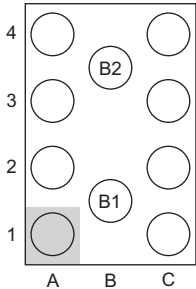
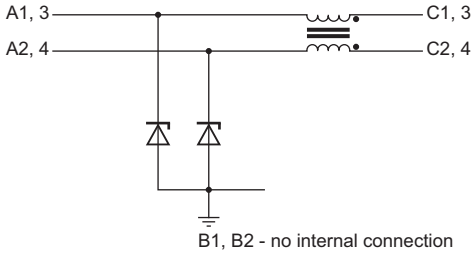
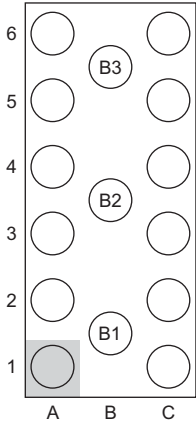
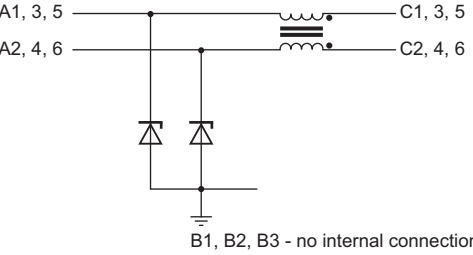
- One, two and three differential channels common-mode EMI filters with integrated ESD protection
- ESD protection up to  $\pm 15$  kV contact discharge according to IEC 61000-4-2
- Superior common-mode suppression over a wide frequency range
- Superior RF performance compared to other integrated filters or discrete filters with external ESD protection
- Extremely high symmetry between line pairs
- Industry-standard Wafer Level Chip Scale Packages: WLCSP5, 10 and 15 for smaller footprint

### 1.3 Applications

- Smartphone, cellular and cordless phone
- Tablet PC and Mobile Internet Device (MID)
- HDMI 2.0, HDMI 1.4
- MIPI M-PHY and D-PHY as used in Camera Serial Interface (CSI) and Display Serial Interface (DSI)
- General-purpose EMI and Radio-Frequency Interference (RFI) filter and downstream ESD protection

## 2. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
<b>PCMF1HDMI2S (WLCSP5_2-1-2)</b>				
A1	CH1_IN+	channel 1+, external	 <p>Transparent top view <b>WLCSP5_2-1-2</b></p>	 <p style="text-align: right;">aaa-019784</p>
A2	CH1_IN-	channel 1-, external		
B1	GND_CH1	ground channel 1		
C1	CH1_OUT+	channel 1+, internal		
C2	CH1_OUT-	channel 1-, internal		
<b>PCMF2HDMI2S (WLCSP10_4-2-4)</b>				
A1	CH1_IN+	channel 1+, external	 <p>Transparent top view <b>WLCSP10_4-2-4</b></p>	 <p style="text-align: right;">B1, B2 - no internal connection aaa-019785</p>
A2	CH1_IN-	channel 1-, external		
A3	CH2_IN+	channel 2+, external		
A4	CH2_IN-	channel 2-, external		
B1	GND_CH1	ground channel 1		
B2	GND_CH2	ground channel 2		
C1	CH1_OUT+	channel 1+, internal		
C2	CH1_OUT-	channel 1-, internal		
C3	CH2_OUT+	channel 2+, internal		
C4	CH2_OUT-	channel 2-, internal		
<b>PCMF3HDMI2S (WLCSP15_6-3-6)</b>				
A1	CH1_IN+	channel 1+, external	 <p>Transparent top view <b>WLCSP15_6-3-6</b></p>	 <p style="text-align: right;">B1, B2, B3 - no internal connection aaa-019786</p>
A2	CH1_IN-	channel 1-, external		
A3	CH2_IN+	channel 2+, external		
A4	CH2_IN-	channel 2-, external		
A5	CH3_IN+	channel 3+, external		
A6	CH3_IN-	channel 3-, external		
B1	GND_CH1	ground channel 1		
B2	GND_CH2	ground channel 2		
B3	GND_CH3	ground channel 3		
C1	CH1_OUT+	channel 1+, internal		
C2	CH1_OUT-	channel 1-, internal		
C3	CH2_OUT+	channel 2+, internal		
C4	CH2_OUT-	channel 2-, internal		
C5	CH3_OUT+	channel 3+, internal		
C6	CH3_OUT-	channel 3-, internal		

### 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PCMF1HDMI2S	WLCSP5	wafer level chip-size package; 5 bumps (2-1-2)	PCMF1HDMI2S
PCMF2HDMI2S	WLCSP10	wafer level chip-size package; 10 bumps (4-2-4)	PCMF2HDMI2S
PCMF3HDMI2S	WLCSP15	wafer level chip-size package; 15 bumps (6-3-6)	PCMF3HDMI2S

### 4. Marking

Table 4. Marking codes

Type number	Marking code
PCMF1HDMI2S	PF1S
PCMF2HDMI2S	PF2S
PCMF3HDMI2S	PF3S

### 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_I$	input voltage		-0.5	5	V
$V_{ESD}$	electrostatic discharge voltage	IEC 61000-4-2, level 4; all input pins to ground			
		contact discharge	-15	15	kV
		air discharge	-15	15	kV
		IEC 61000-4-2, level 4; all output pins to ground			
		contact discharge	-2	2	kV
		air discharge	-2	2	kV
$I_{PPM}$	rated peak pulse current	$t_p = 8/20 \mu s$	-7	7	A
$T_{stg}$	storage temperature		-40	+125	°C
$T_{amb}$	ambient temperature		-40	+85	°C

## 6. Characteristics

### 6.1 Channel characteristics

**Table 6. Channel characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{s(ch)}$	channel series resistance	single line; input to output	-	3	-	$\Omega$
$C_d$	diode capacitance	$f = 1\text{ MHz}$ ; $V_I = 2.5\text{ V}$ [1]	-	0.25	-	pF
$I_{RM}$	reverse leakage current	per line; $V_I = 5\text{ V}$	-	-	100	nA
$V_{BR}$	breakdown voltage	$I_R = 1\text{ mA}$	6	9	-	V
$V_F$	forward voltage	$I_F = 10\text{ mA}$	-	0.8	-	V
$V_{CL}$	clamping voltage	TLP [2]				
		$I_{PP} = -16\text{ A}$	-	-3.7	-	V
		$I_{PP} = -8\text{ A}$	-	-2.5	-	V
		$I_{PP} = 8\text{ A}$	-	2.8	-	V
$R_{dyn}$	dynamic resistance	TLP [2]				
		positive transient	-	0.16	-	$\Omega$
		negative transient	-	0.16	-	$\Omega$
		surge [3]				
		positive transient	-	0.22	-	$\Omega$
	negative transient	-	0.22	-	$\Omega$	

[1] This parameter is guaranteed by design.

[2] 100 ns Transmission Line Pulse (TLP); 50  $\Omega$ ; pulser at 70 ns to 90 ns.

[3] According to IEC 61000-4-5 (8/20  $\mu\text{s}$ ).

### 6.2 Frequency characteristics

**Table 7. Frequency characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Common mode: <math>S_{21cc}</math></b>						
$\alpha_{il}$	insertion loss	[1]				
		$f = 800\text{ MHz}$	-	-12	-	dB
		$f = 1.7\text{ GHz}$	-	-21.5	-	dB
		$f = 3\text{ GHz}$	-	-31.5	-	dB
<b>Differential mode: <math>S_{21dd}</math></b>						
$\alpha_{il}$	insertion loss	$f = 1\text{ MHz}$ [1]	-	0.3	-	dB
$f_{-3dB}$	cut-off frequency	[1]	-	6	-	GHz

[1] Normalized to attenuation at 1 MHz.

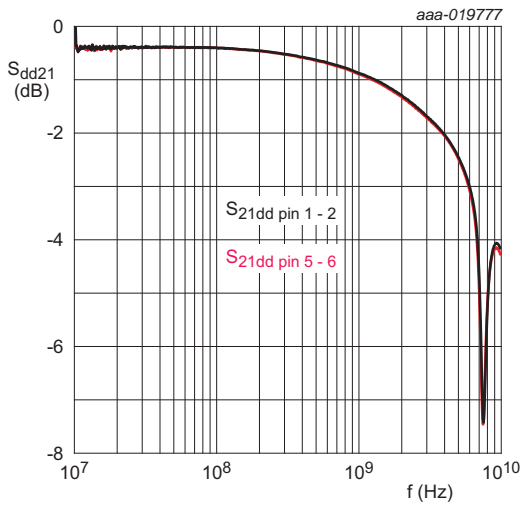


Fig 1. Differential-mode insertion loss; typical values

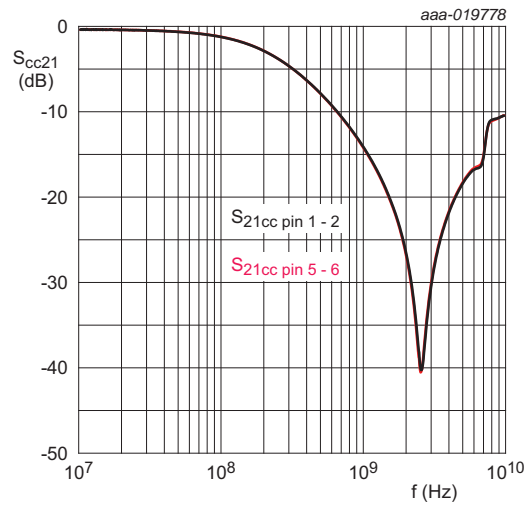


Fig 2. Common-mode insertion loss; typical values

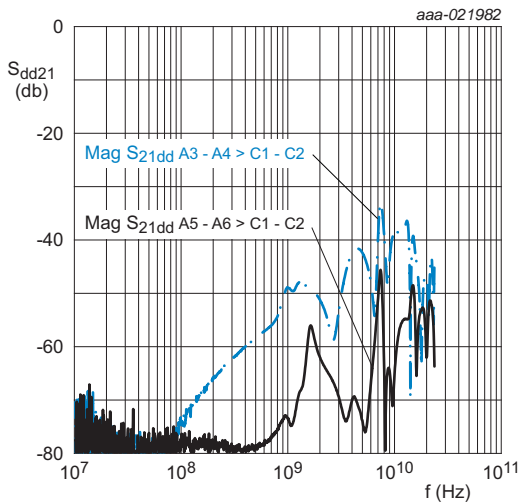


Fig 3. Differential crosstalk; typical values

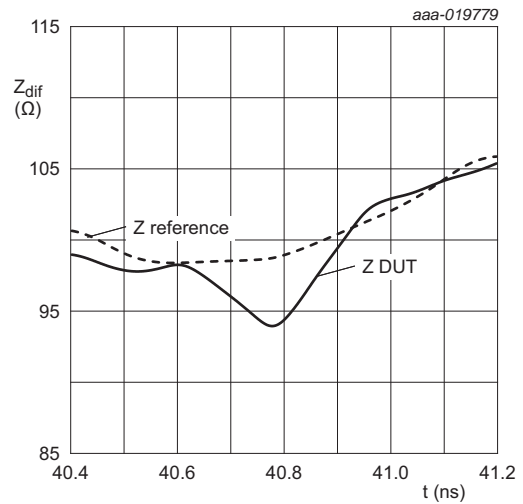
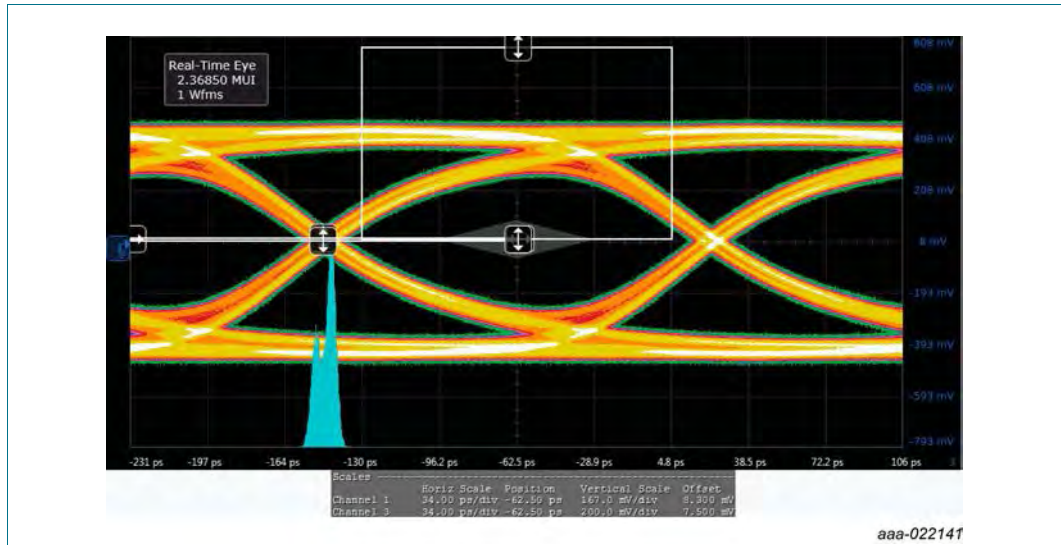
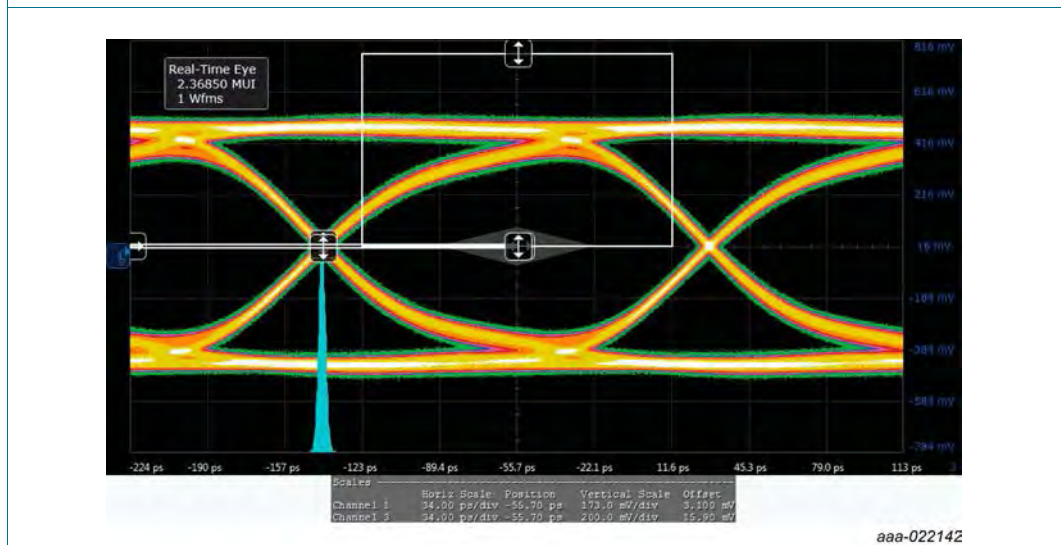


Fig 4. Differential Time Domain Reflectometer (TDR) plot; typical values



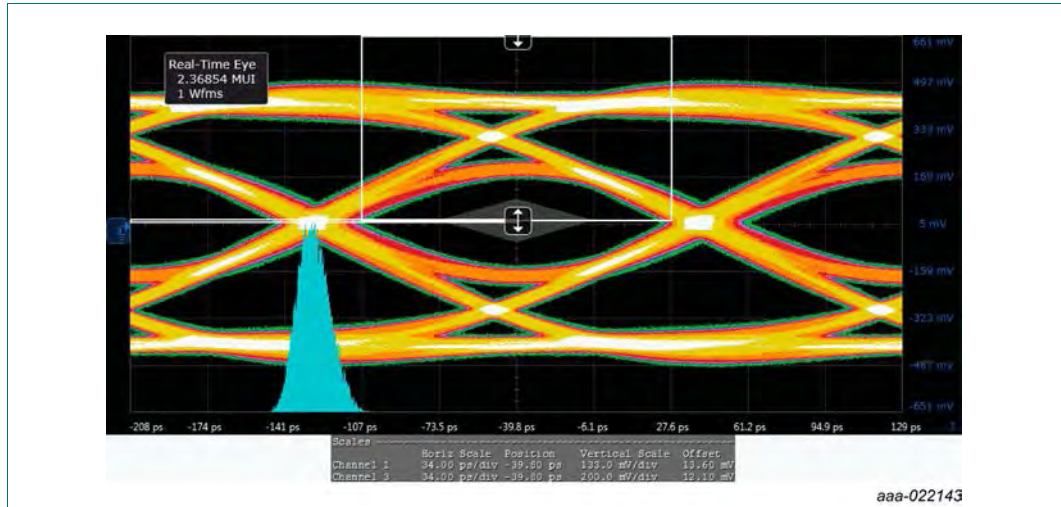
Test frequency: 148.5 MHz  
 Differential swing voltage: 861 mV  
 Horizontal scale: 34 ps/div

**Fig 5. HDMI 2.0 eye diagram TP1, test board with PCMF2HDMI2S; typical values**



Test frequency: 148.5 MHz  
 Differential swing voltage: 917 mV  
 Horizontal scale: 34 ps/div

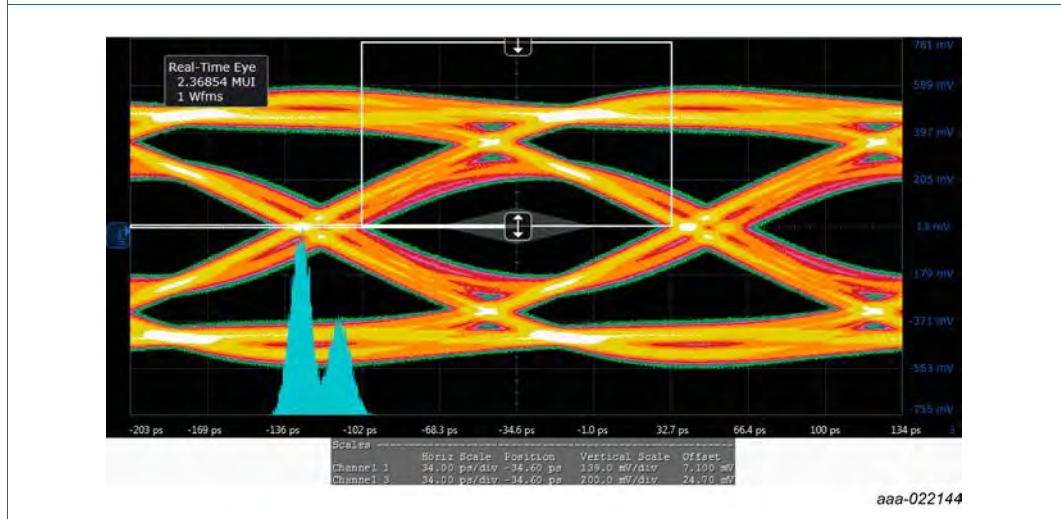
**Fig 6. HDMI 2.0 eye diagram TP1, test board without device; typical values**



Test frequency: 148.5 MHz  
 Differential swing voltage: 849 mV  
 Horizontal scale: 34 ps/div

**Remark:** Measured at Test Point 2 (TP2) worst cable emulator, reference cable equalizer and worst case positive skew.

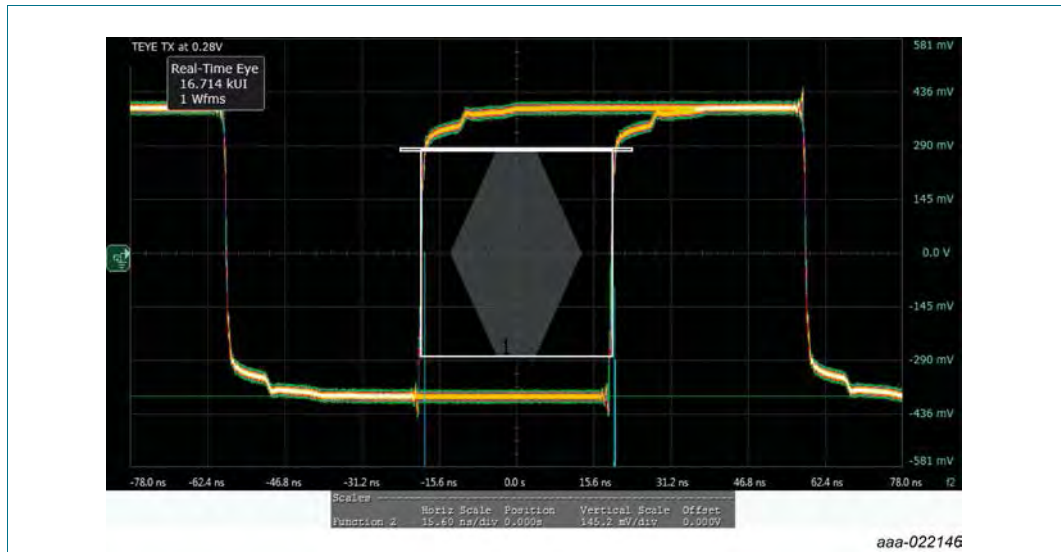
**Fig 7. HDMI 2.0 eye diagram TP2, test board with PCMF2HDMI2S; typical values**



Test frequency: 148.5 MHz  
 Differential swing voltage: 909 mV  
 Horizontal scale: 34 ps/div

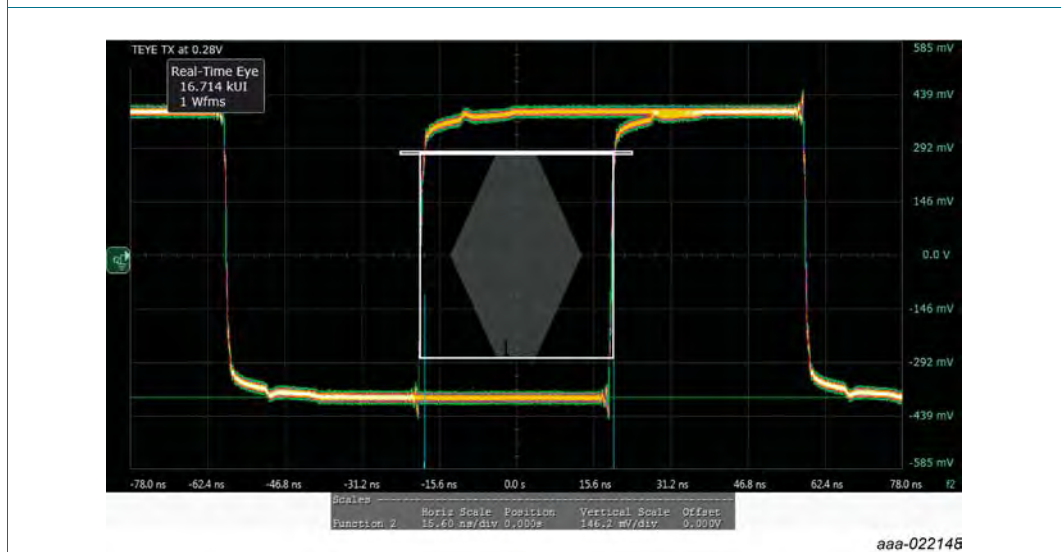
**Remark:** Measured at Test Point 2 (TP2) worst cable emulator, reference cable equalizer and worst case positive skew.

**Fig 8. HDMI 2.0 eye diagram TP2, test board without device; typical values**



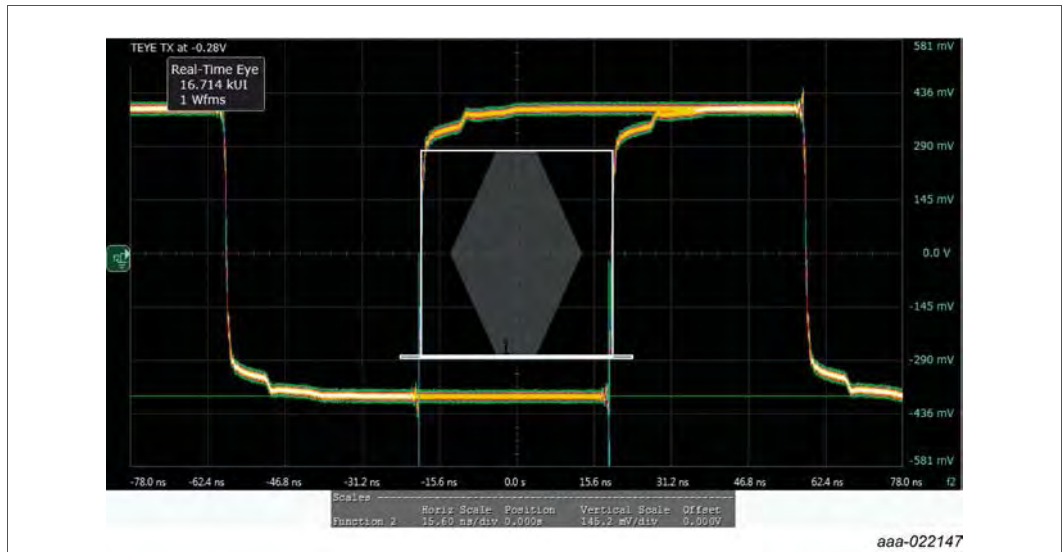
Vertical scale: 145 mV/div  
Horizontal scale: 15.6 ns/div

Fig 9. MIPI M-PHY PWM-TX transmitter eye opening at 140 mV, test board with PCMF2HDMI2S; typical values



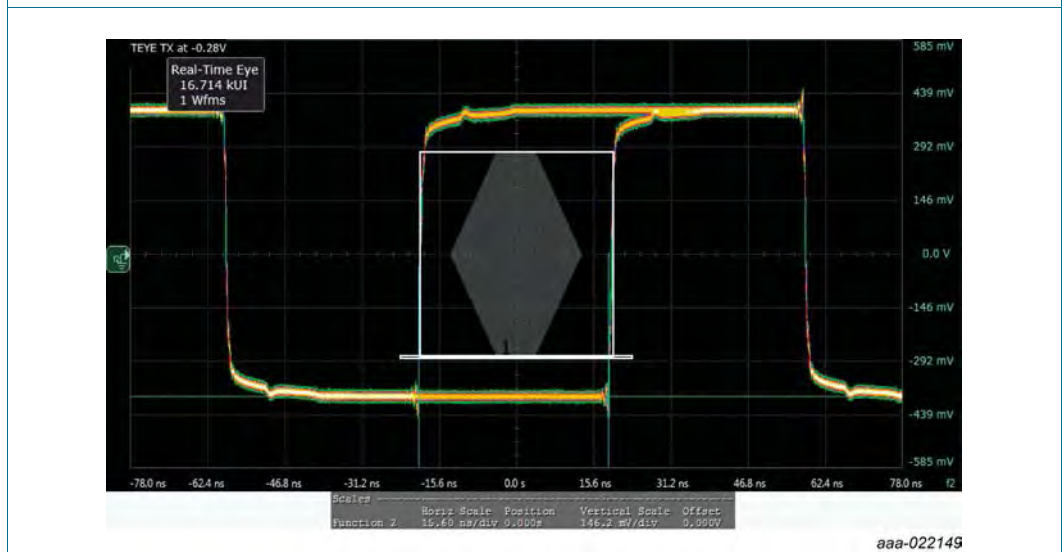
Vertical scale: 146 mV/div  
Horizontal scale: 15.6 ns/div

Fig 10. MIPI M-PHY PWM-TX transmitter eye opening at 140 mV, test board without device; typical values



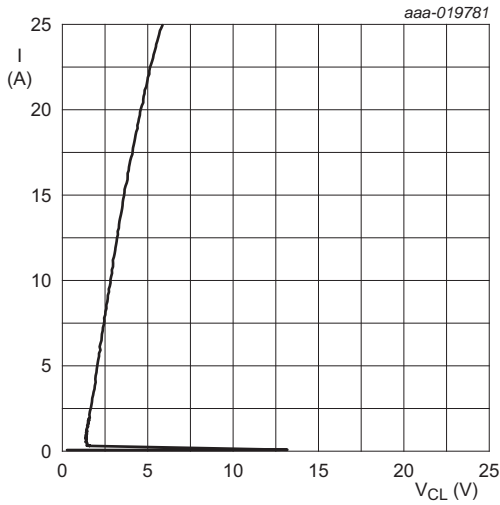
Vertical scale: 145 mV/div  
 Horizontal scale: 15.6 ns/div

**Fig 11. MIPI M-PHY PWM-TX transmitter eye opening at -140 mV, test board with PCMF2HDMI2S; typical values**



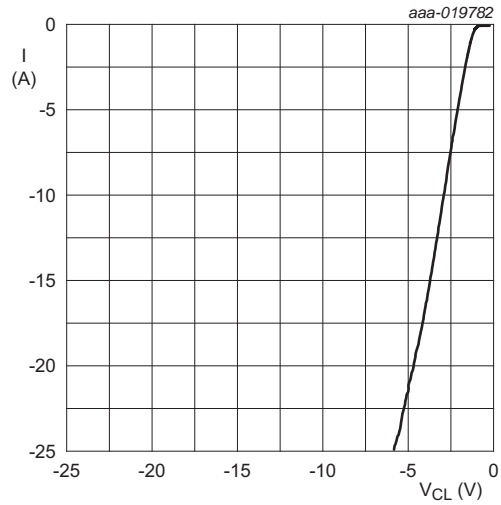
Vertical scale: 146 mV/div  
 Horizontal scale: 15.6 ns/div

**Fig 12. MIPI M-PHY PWM-TX transmitter eye opening at -140 mV, test board without device; typical values**



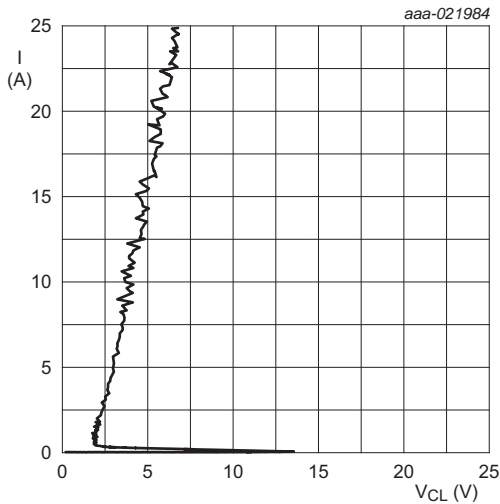
Transmission Line Pulse (TLP) = 100 ns;  
 $t_r = 1$  ns

**Fig 13. Dynamic resistance with positive clamping; typical values**



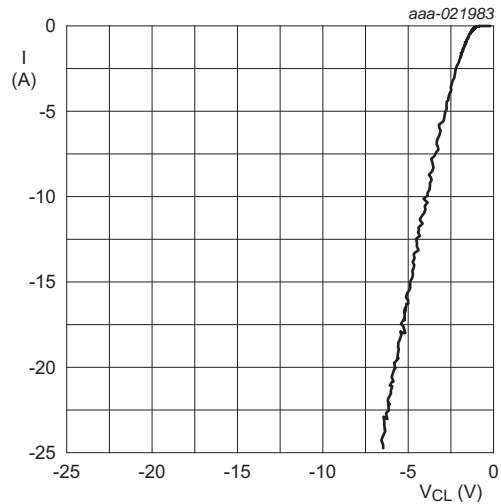
Transmission Line Pulse (TLP) = 100 ns;  
 $t_r = 1$  ns

**Fig 14. Dynamic resistance with negative clamping; typical values**



Very-Fast Transmission Line Pulse (VF-TLP) = 5 ns;  
 $t_r = 600$  ps

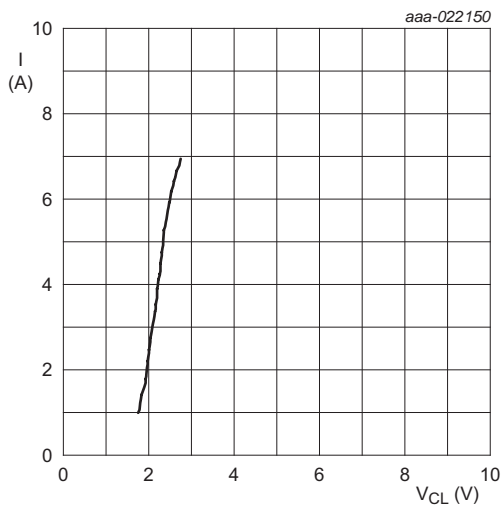
**Fig 15. Dynamic resistance with positive clamping; typical values**



Very-Fast Transmission Line Pulse (VF-TLP) = 5 ns;  
 $t_r = 600$  ps

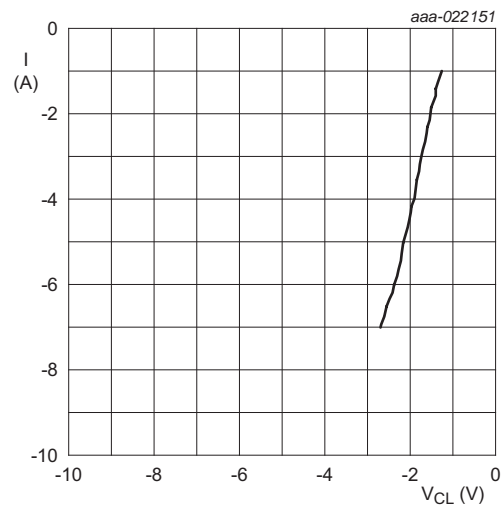
**Fig 16. Dynamic resistance with negative clamping; typical values**

The device uses an advanced clamping structure showing a negative dynamic resistance. This snapback behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snapback state after exceeding breakdown voltage (due to an ESD pulse for instance).



According to IEC 61000-4-5 (8/20  $\mu$ s)

**Fig 17. Dynamic resistance with positive clamping; typical values**



According to IEC 61000-4-5 (8/20  $\mu$ s)

**Fig 18. Dynamic resistance with negative clamping; typical values**

## 7. Application information

The device is designed to provide high-level ESD protection and common-mode filtering for differential high-speed data line pairs such as:

- HDMI 2.0
- Transition-Minimized Differential Signaling (TMDS)
- DisplayPort
- external Serial Advanced Technology Attachment (eSATA)
- Low Voltage Differential Signaling (LVDS)

When designing the PCB, give careful consideration to impedance matching and signal coupling. Do not connect the protected signal lines to unlimited current sources like, for example, a battery.

8. Package outline

WLCSP5: wafer level chip-size package; 5 bumps (2-1-2)

PCMF1HDMI2S

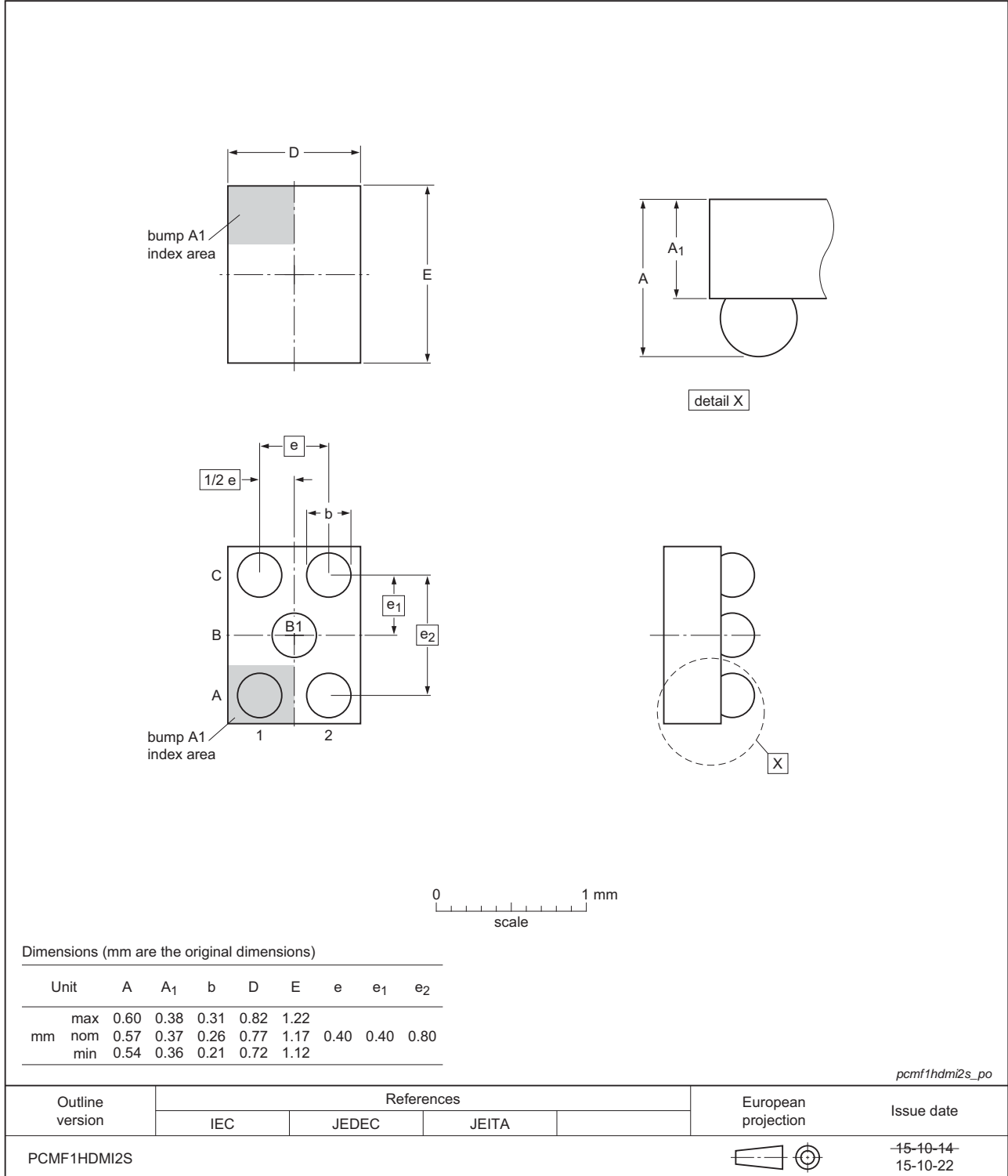


Fig 19. Package outline WLCSP5

WLCSP10: wafer level chip-size package; 10 bumps (4-2-4)

PCMF2HDMI2S

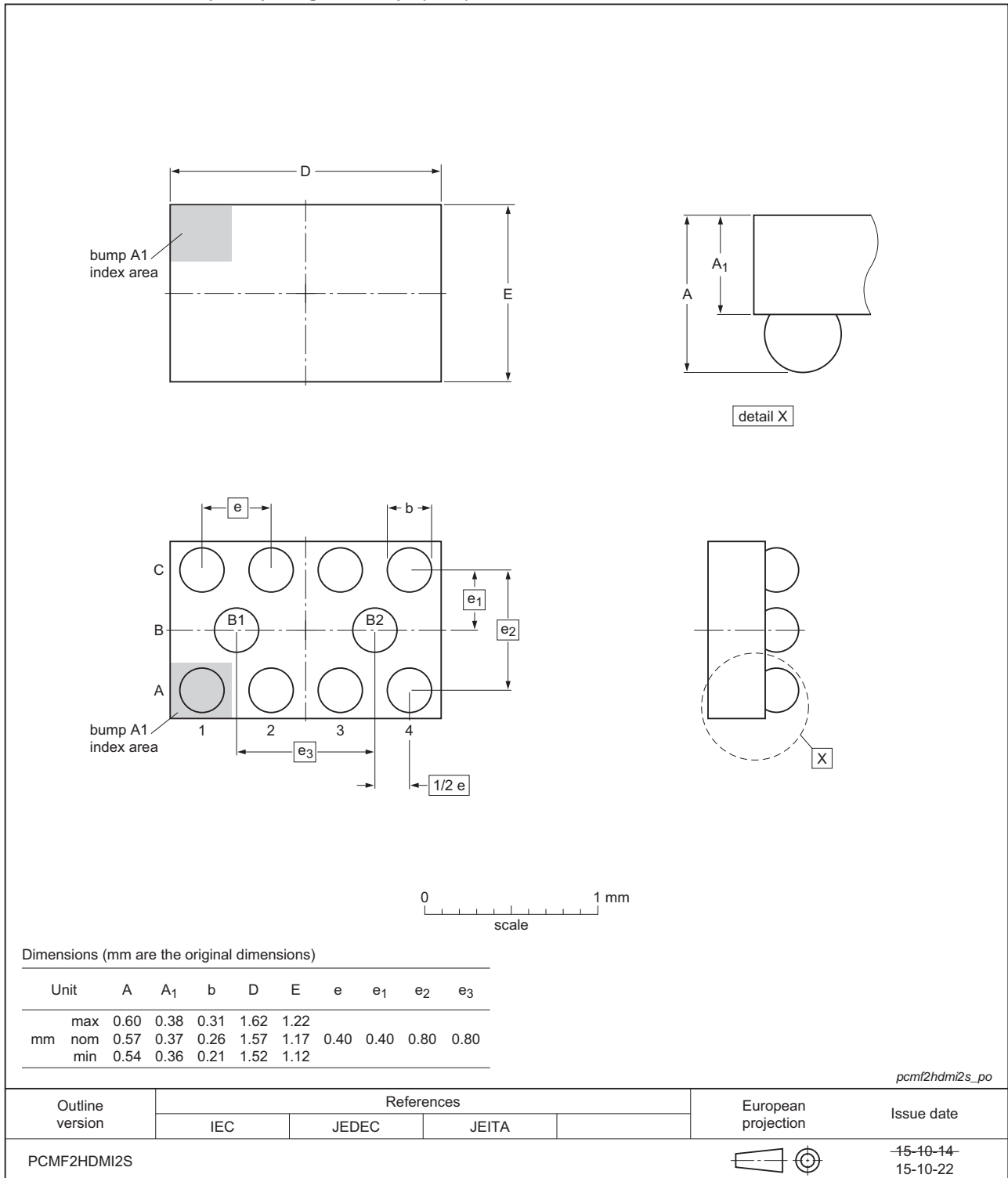


Fig 20. Package outline WLCSP10

WLCSP15: wafer level chip-size package; 15 bumps (6-3-6)

PCMF3HDMI2S

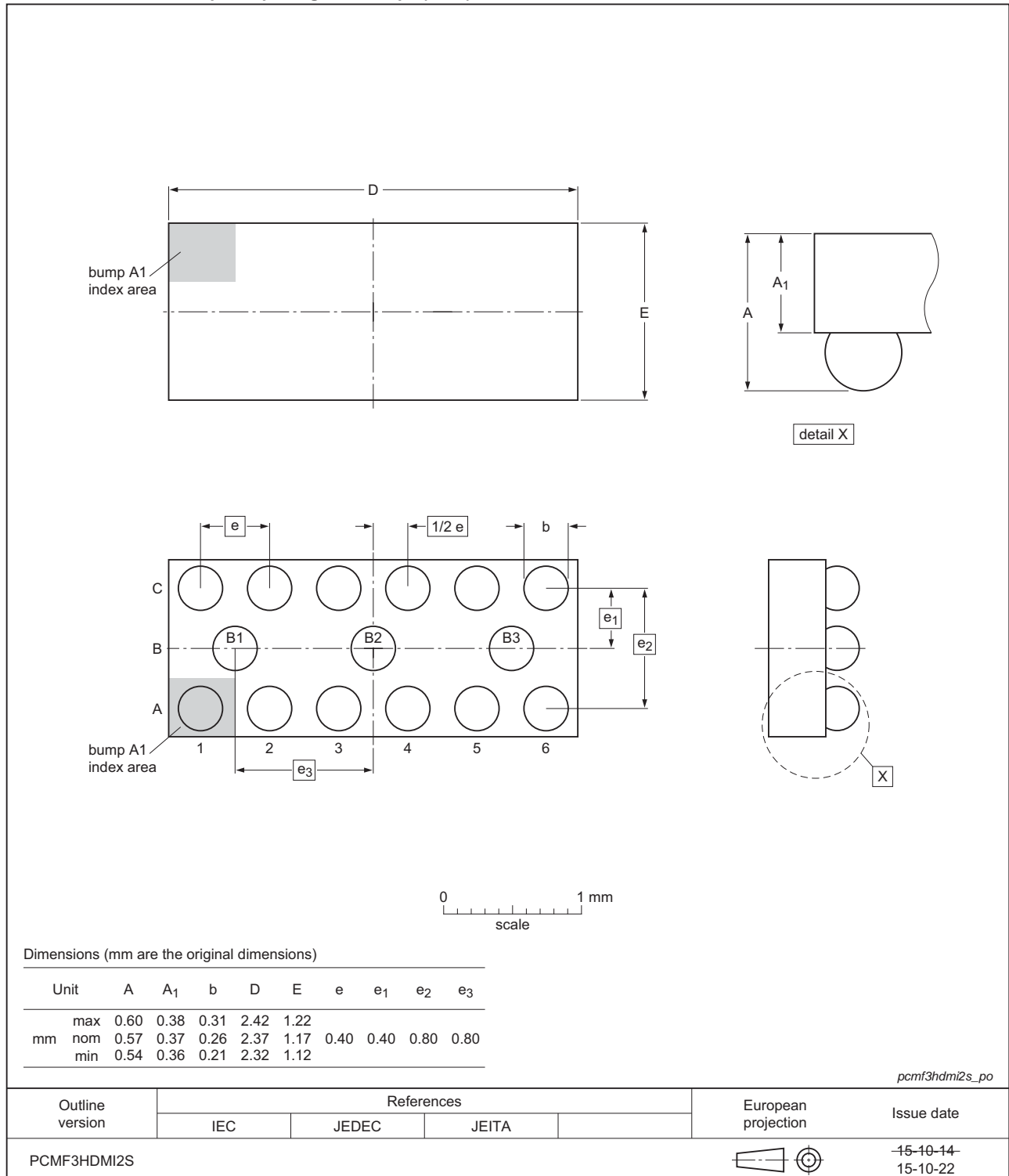
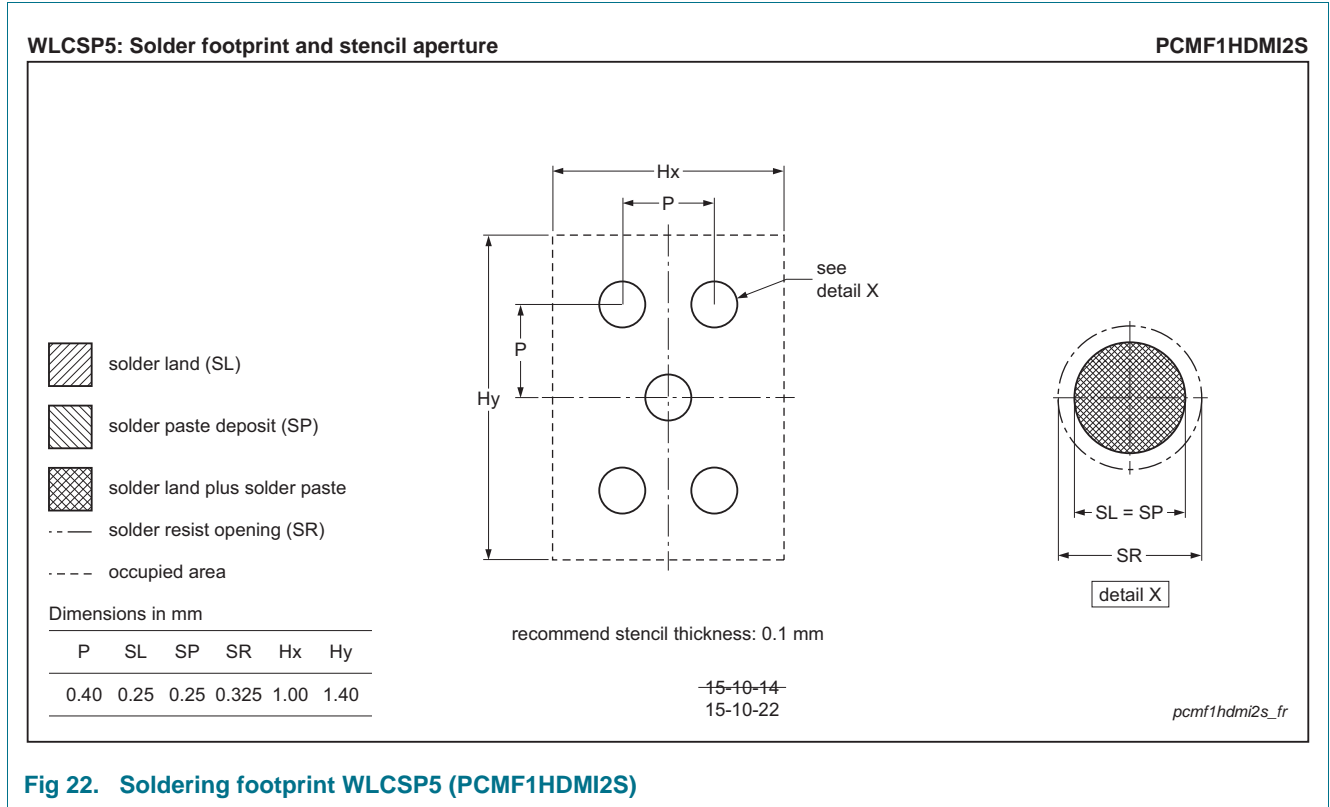


Fig 21. Package outline WLCSP15

9. Soldering



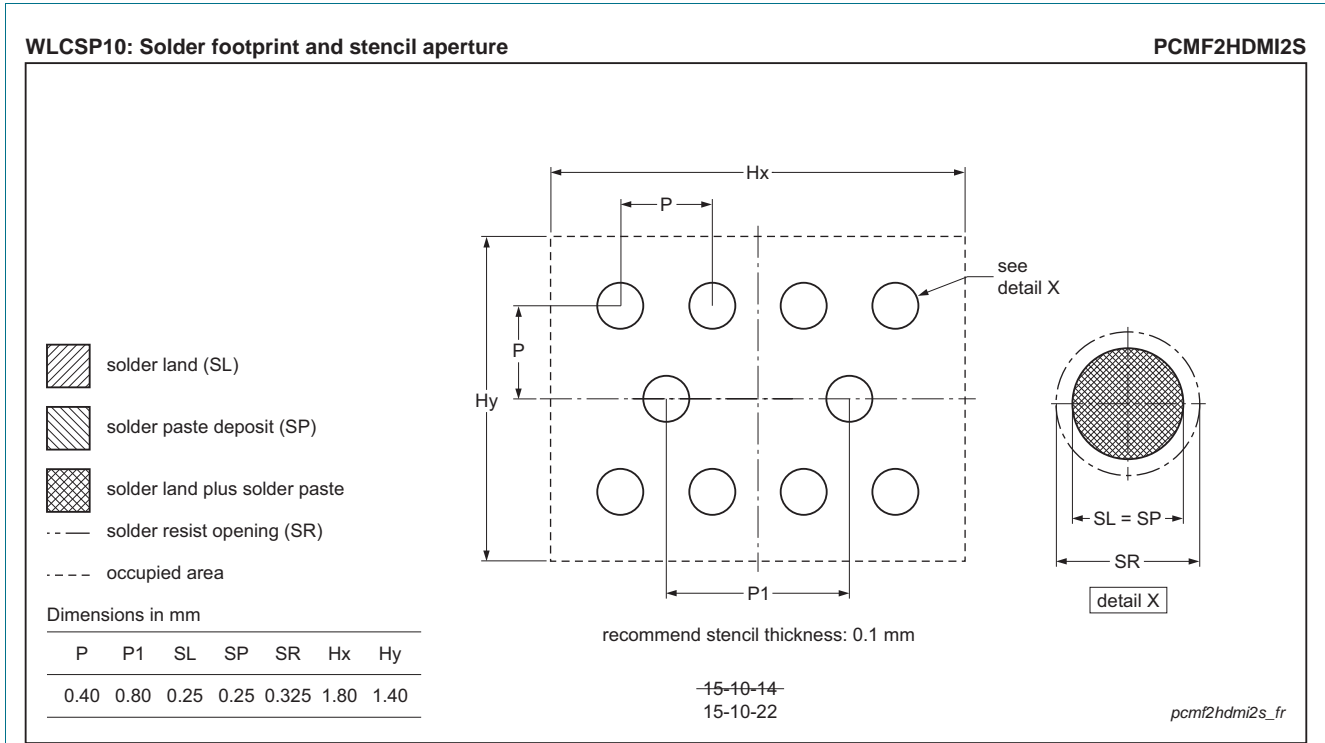


Fig 23. Soldering footprint WLCSP10 (PCMF2HDMI2S)

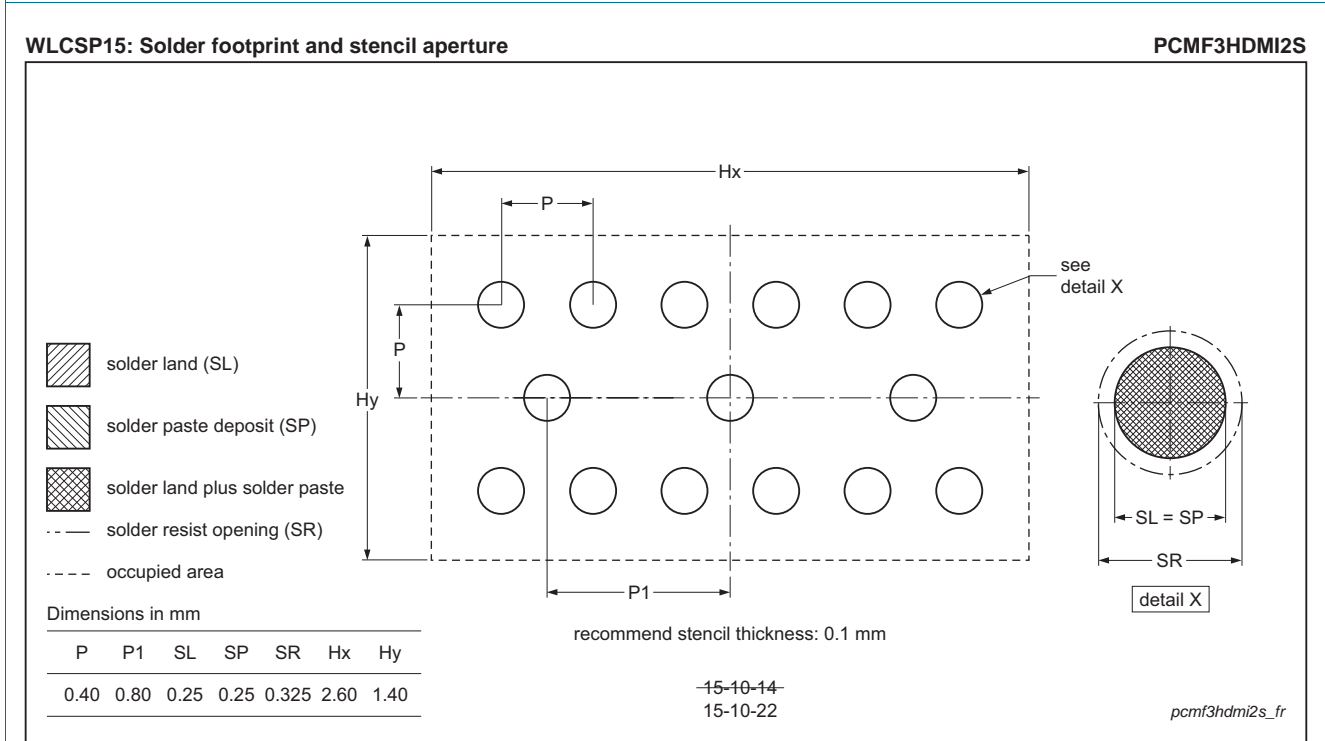


Fig 24. Soldering footprint WLCSP15 (PCMF3HDMI2S)

## 10. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PCMFXHDMI2S_SER v.2	20160419	Product data sheet	-	PCMFXHDMI2S_SER v.1
Modifications:	<ul style="list-style-type: none"> <li>• <a href="#">Section 1 "Product profile"</a>: updated</li> <li>• <a href="#">Section 6.1</a>: clamping voltage <math>V_{CL}</math> added; dynamic resistance <math>R_{dyn}</math> updated</li> <li>• <a href="#">Section 6.2</a>: insertion loss <math>\alpha_{il}</math> updated</li> <li>• <a href="#">Figure 3</a>: added</li> <li>• <a href="#">Figure 5</a> to <a href="#">Figure 8</a>: updated</li> <li>• <a href="#">Figure 9</a> to <a href="#">Figure 12</a> and <a href="#">Figure 15</a> to <a href="#">Figure 18</a>: added</li> <li>• <a href="#">Section 7 "Application information"</a>: added</li> </ul>			
PCMFXHDMI2S_SER v.1	20151126	Preliminary data sheet	-	-

## 11. Legal information

### 11.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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## 12. Contact information

For more information, please visit: <http://www.nexperia.com>

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